

## High Isolation, Linear Current Sensor IC with 850 $\mu\Omega$ Current Conductor

### Not for New Design

The ACS718 is in production but has been determined to be NOT FOR NEW DESIGN. This classification indicates that sale of this device is currently restricted to existing customer applications. The device should not be purchased for new design applications because obsolescence in the near future is probable. Samples are no longer available.

Date of status change: November 1, 2023

#### Recommended Substitutions:

*For existing customer transition, and for new customers or new applications, refer to [ACS37002](#) (recommended for its high accuracy and included features) or [ACS724](#).*

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NOTE: For detailed information on purchasing options, contact your local Allegro field applications engineer or sales representative.

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# High Isolation Linear Current Sensor IC with 850 $\mu\Omega$ Current Conductor

## FEATURES AND BENEFITS

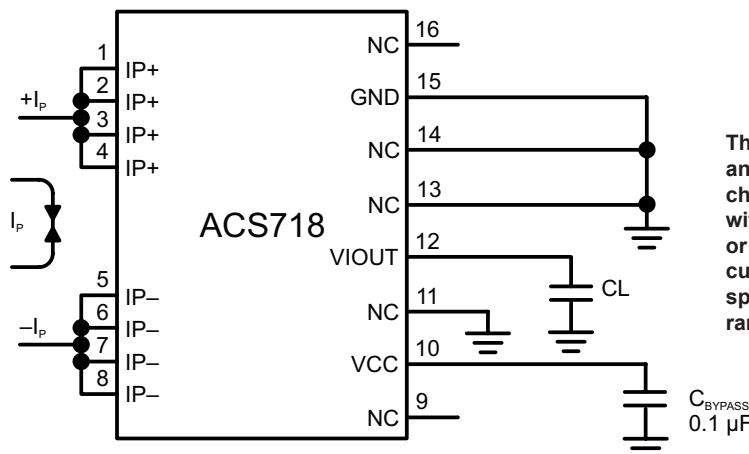
- IEC/UL 60950-1 Ed. 2 certified to:
  - Dielectric Strength = 4800 Vrms (tested for 60 seconds)
  - Basic Isolation = 1550 Vpeak
  - Reinforced Isolation = 800 Vpeak
- Small footprint, low-profile SOIC16 wide-body package suitable for space constrained applications that require high galvanic isolation
- 0.85 m $\Omega$  primary conductor for low power loss and high inrush current withstand capability
- Low, 350  $\mu\text{A}_{\text{RMS}}/\sqrt{\text{Hz}}$  noise density results in typical input referred noise of 70 mA(rms) at max bandwidth (40 kHz)
- 5.0 V, single supply operation
- Output voltage proportional to AC or DC current
- Factory-trimmed sensitivity and quiescent output voltage for improved accuracy
- Chopper stabilization results in extremely stable quiescent output voltage
- Ratiometric output from supply voltage



## Package: 16-Pin SOICW (suffix MA)



*Not to scale*



Typical Application

## SPECIFICATIONS

## SELECTION GUIDE

| Part Number           | $I_p$<br>(A) | Sens(Typ)<br>at $V_{CC} = 5.0$ V<br>(mV/A) | $T_A$<br>(°C) | Packing [1]                         |
|-----------------------|--------------|--|---------------|-------------------------------------|
| ACS718KMATR-10B-T [2] | $\pm 10$     | 200  |               |                                     |
| ACS718KMATR-20B-T [2] | $\pm 20$     | 100  | -40 to 125    | Tape and reel, 1000 pieces per reel |



[1] Contact Allegro for additional packing options.

[2] Variant not intended for automotive applications.

## ABSOLUTE MAXIMUM RATINGS

| Characteristic                | Symbol       | Notes   | Rating     | Units |
|-------------------------------|--------------|---------|------------|-------|
| Supply Voltage                | $V_{CC}$     |         | 7          | V     |
| Reverse Supply Voltage        | $V_{RCC}$    |         | -0.1       | V     |
| Output Voltage                | $V_{IOUT}$   |         | 25         | V     |
| Reverse Output Voltage        | $V_{RIOUT}$  |         | -0.1       | V     |
| Operating Ambient Temperature | $T_A$        | Range K | -40 to 125 | °C    |
| Junction Temperature          | $T_{J(max)}$ |         | 165        | °C    |
| Storage Temperature           | $T_{stg}$    |         | -65 to 165 | °C    |

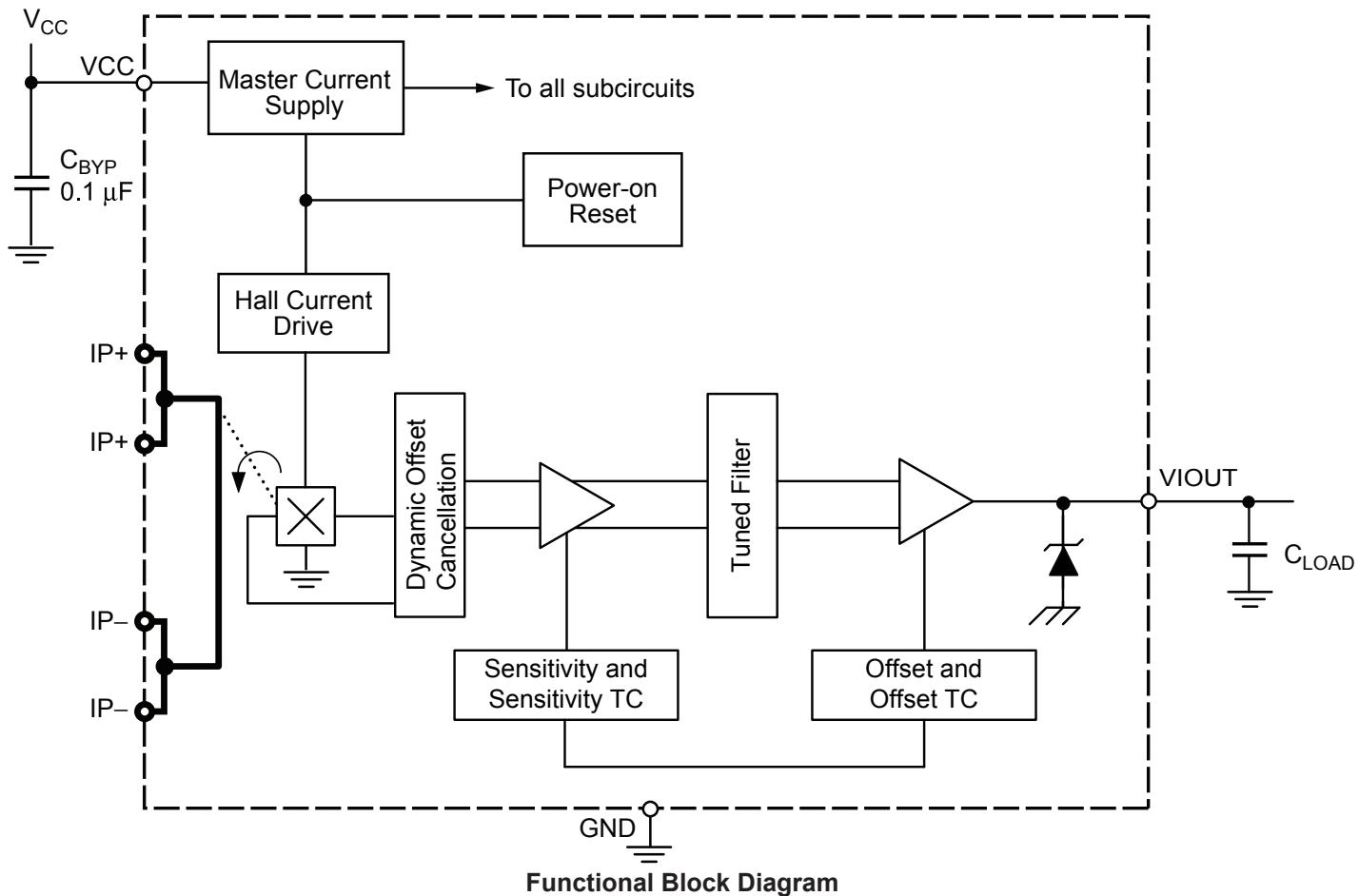
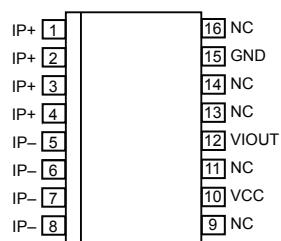
## ESD RATINGS

| Characteristic       | Symbol    | Notes | Rating  | Units |
|----------------------|-----------|-------|---------|-------|
| Human Body Model     | $V_{HBM}$ |       | $\pm 8$ | kV    |
| Charged Device Model | $V_{CDM}$ |       | $\pm 1$ | kV    |

## ISOLATION CHARACTERISTICS

| Characteristic                           | Symbol     | Notes   | Rating     | Unit            |
|--|------------|---|------------|-----------------|
| Dielectric Strength Test Voltage         | $V_{ISO}$  | Agency type tested for 60 seconds per IEC/UL 60950-1 (2nd Edition). Production tested for 1 second at 3000 $V_{RMS}$ in accordance with IEC/UL 60950-1 (2nd Edition). | 4800       | $V_{RMS}$       |
| Working Voltage for Basic Isolation      | $V_{WVBI}$ | Maximum approved working voltage for basic (single) isolation according to IEC/UL 60950-1 (2nd Edition).  | 1550       | $V_{PK}$ or VDC |
|  |            |   | 1097       | $V_{RMS}$       |
| Working Voltage for Reinforced Isolation | $V_{WVRI}$ | Maximum approved working voltage for reinforced isolation according to IEC/UL 60950-1 (2nd Edition)   | 800        | $V_{PK}$ or VDC |
|  |            |   | 565        | $V_{RMS}$       |
| Clearance                                | $D_{cl}$   | Minimum distance through air from IP leads to signal leads.   | 7.5        | mm              |
| Creepage [1]                             | $D_{cr}$   | Minimum distance along package body from IP leads to signal leads.  | 8.2        | mm              |
| Distance Through Insulation              | DTI        | Minimum internal distance through insulation  | 90         | $\mu m$         |
| Comparative Tracking Index               | CTI        | Material Group II   | 400 to 599 | V               |

[1] In order to maintain this creepage in applications, the user should add a slit in the PCB under the package. Otherwise, the pads on the PCB will reduce the creepage.

**Pinout Diagram and Terminal List Table****Package MA, 16-Pin  
SOICW****Terminal List**

| Number     | Name | Description  |
|------------|------|--|
| 1, 2, 3, 4 | IP+  | Terminals for current being sensed; fused internally   |
| 5, 6, 7, 8 | IP-  | Terminals for current being sensed; fused internally   |
| 9, 16      | NC   | No internal connection; recommended to be left unconnected in order to maintain high creepage. |
| 11, 13, 14 | NC   | No internal connection; recommended to connect to GND for the best ESD performance             |
| 10         | VCC  | Device power supply terminal   |
| 12         | VOUT | Analog output signal   |
| 15         | GND  | Signal ground terminal   |

**COMMON ELECTRICAL CHARACTERISTICS<sup>[1]</sup>:  $T_A$  Range K, valid at  $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ,  $V_{CC} = 5 \text{ V}$ , unless otherwise specified**

| Characteristic                    | Symbol         | Test Conditions  | Min.           | Typ.    | Max. | Units   |
|-----------------------------------|----------------|--|----------------|---------|------|---|
| Supply Voltage                    | $V_{CC}$       |  | 4.5            | 5       | 5.5  | V   |
| Supply Current                    | $I_{CC}$       | $V_{CC} = 5 \text{ V}$ , output open   | —              | 7       | 9    | mA  |
| Output Capacitance Load           | $C_L$          | VOUT to GND  | —              | —       | 1    | nF  |
| Output Resistive Load             | $R_L$          | VOUT to GND  | 15             | —       | —    | k $\Omega$                                    |
| Primary Conductor Resistance      | $R_P$          | $T_A = 25^\circ\text{C}$   | —              | 0.85    | —    | m $\Omega$                                    |
| Primary Conductor Inductance      | $L_{IP}$       | $T_A = 25^\circ\text{C}$   | —              | 4       | —    | nH  |
| Magnetic Coupling Factor          | $C_F$          |  | —              | 4.5     | —    | G/A   |
| Rise Time                         | $t_r$          | $T_A = 25^\circ\text{C}$ , $C_L = 0 \text{ nF}$  | —              | 10      | —    | $\mu\text{s}$                                 |
| Propagation Delay                 | $t_{pd}$       | $T_A = 25^\circ\text{C}$ , $C_L = 0 \text{ nF}$  | —              | 5       | —    | $\mu\text{s}$                                 |
| Response Time                     | $t_{RESPONSE}$ | $T_A = 25^\circ\text{C}$ , $C_L = 0 \text{ nF}$  | —              | 13      | —    | $\mu\text{s}$                                 |
| Output Slew Rate                  | SR             | $T_A = 25^\circ\text{C}$ , $C_L = 0 \text{ nF}$  | —              | 0.16    | —    | V/ $\mu\text{s}$                              |
| Internal Bandwidth                | BWi            | Small signal $-3 \text{ dB}$   | —              | 40      | —    | kHz   |
| Noise Density                     | $I_{ND}$       | Input referenced noise density;<br>$T_A = 25^\circ\text{C}$ , $C_L = 1 \text{ nF}$       | —              | 350     | —    | $\mu\text{A}_{(\text{rms})}/\sqrt{\text{Hz}}$ |
| Noise                             | $I_N$          | Input referenced noise; BWi = 40 kHz,<br>$T_A = 25^\circ\text{C}$ , $C_L = 1 \text{ nF}$ | —              | 70      | —    | $\text{mA}_{(\text{rms})}$                    |
| Nonlinearity                      | $E_{LIN}$      | Across full range of $I_P$   | —              | $\pm 1$ | —    | %   |
| Saturation Voltage <sup>[2]</sup> | $V_{OH}$       | $R_L = R_L(\text{min})$  | $V_{CC} - 0.3$ | —       | —    | V   |
|                                   | $V_{OL}$       | $R_L = R_L(\text{min})$  | —              | —       | 0.3  | V   |
| Power-On Time                     | $t_{PO}$       | $T_A = 25^\circ\text{C}$   | —              | 35      | —    | $\mu\text{s}$                                 |

<sup>[1]</sup> Device may be operated at higher primary current levels,  $I_P$ , ambient temperatures,  $T_A$ , and internal leadframe temperatures, provided the Maximum Junction Temperature,  $T_J(\text{max})$ , is not exceeded.

<sup>[2]</sup> The sensor IC will continue to respond to current beyond the range of  $I_P$  until the high or low saturation voltage; however, the nonlinearity in this region will be worse than through the rest of the measurement range.

# ACS718

## High Isolation Linear Current Sensor IC with 850 $\mu\Omega$ Current Conductor

**XKMATR-10B PERFORMANCE CHARACTERISTICS: Valid at  $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ,  $V_{CC} = 5 \text{ V}$ , unless otherwise specified**

| Characteristic   | Symbol            | Test Conditions  | Min. | Typ. [1]            | Max. | Units |
|--|-------------------|--|------|---------------------|------|-------|
| <b>NOMINAL PERFORMANCE</b>   |                   |  |      |                     |      |       |
| Current Sensing Range  | $I_{PR}$          |  | -10  | -                   | 10   | A     |
| Sensitivity  | Sens              | $I_{PR}(\min) < I_P < I_{PR}(\max)$                                | -    | 200                 | -    | mV/A  |
| Zero Current Output Voltage  | $V_{IOUT(Q)}$     | Bidirectional; $I_P = 0 \text{ A}$                                 | -    | $V_{CC} \times 0.5$ | -    | V     |
| <b>ACCURACY PERFORMANCE</b>  |                   |  |      |                     |      |       |
| Total Output Error [2]   | $E_{TOT}$         | $I_P = I_{PR}(\max); T_A = 25^\circ\text{C}$                       | -5   | $\pm 2$             | 5    | %     |
|  |                   | $I_P = I_{PR}(\max); T_A = 85^\circ\text{C}$                       | -    | $\pm 2$             | -    | %     |
|  |                   | $I_P = I_{PR}(\max); T_A = 125^\circ\text{C}$                      | -    | $\pm 4$             | -    | %     |
|  |                   | $I_P = I_{PR}(\max); T_A = -40^\circ\text{C}$                      | -    | $\pm 4$             | -    | %     |
| <b>TOTAL OUTPUT ERROR COMPONENTS [3] <math>E_{TOT} = E_{SENS} + 100 \times V_{OE}/(Sens \times I_P)</math></b> |                   |  |      |                     |      |       |
| Sensitivity Error  | $E_{SENS}$        | $T_A = 25^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$  | -4   | $\pm 2$             | 4    | %     |
|  |                   | $T_A = 85^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$  | -    | $\pm 2$             | -    | %     |
|  |                   | $T_A = 125^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$ | -    | $\pm 3$             | -    | %     |
|  |                   | $T_A = -40^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$ | -    | $\pm 4$             | -    | %     |
| Voltage Offset Error [4]   | $V_{OE}$          | $T_A = 25^\circ\text{C}; I_P = 0 \text{ A}$                        | -40  | $\pm 10$            | 40   | mV    |
|  |                   | $T_A = 85^\circ\text{C}; I_P = 0 \text{ A}$                        | -    | $\pm 15$            | -    | mV    |
|  |                   | $T_A = 125^\circ\text{C}; I_P = 0 \text{ A}$                       | -    | $10 \pm 20$         | -    | mV    |
|  |                   | $T_A = -40^\circ\text{C}; I_P = 0 \text{ A}$                       | -    | $\pm 25$            | -    | mV    |
| <b>LIFETIME DRIFT CHARACTERISTICS</b>  |                   |  |      |                     |      |       |
| Sensitivity Error Lifetime Drift   | $E_{SENS\_DRIFT}$ |  | -    | $\pm 2$             | -    | %     |
| Total Output Error Lifetime Drift  | $E_{TOT\_DRIFT}$  |  | -    | $\pm 2$             | -    | %     |

[1] Typical values with  $\pm$  are 3 sigma values.

[2] Percentage of  $I_P$ , with  $I_P = I_{PR}(\max)$ .

[3] A single part will not have both the maximum/minimum sensitivity error and maximum/minimum offset voltage, as that would violate the maximum/minimum total output error specification. Also, 3 sigma distribution values are combined by taking the square root of the sum of the squares. See Application Information section.

[4] Voltage Offset Error does not incorporate any error due to external magnetic fields. See section: Impact of External Magnetic Fields.

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**xKMATR-20B PERFORMANCE CHARACTERISTICS: Valid at  $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ,  $V_{CC} = 5 \text{ V}$ , unless otherwise specified**

| Characteristic   | Symbol            | Test Conditions  | Min. | Typ. [1]            | Max. | Units |
|--|-------------------|--|------|---------------------|------|-------|
| <b>NOMINAL PERFORMANCE</b>   |                   |  |      |                     |      |       |
| Current Sensing Range  | $I_{PR}$          |  | -20  | -                   | 20   | A     |
| Sensitivity  | Sens              | $I_{PR}(\min) < I_P < I_{PR}(\max)$                                | -    | 100                 | -    | mV/A  |
| Zero Current Output Voltage  | $V_{IOUT(Q)}$     | Bidirectional; $I_P = 0 \text{ A}$                                 | -    | $V_{CC} \times 0.5$ | -    | V     |
| <b>ACCURACY PERFORMANCE</b>  |                   |  |      |                     |      |       |
| Total Output Error [2]   | $E_{TOT}$         | $I_P = I_{PR}(\max); T_A = 25^\circ\text{C}$                       | -5   | $\pm 2$             | 5    | %     |
|  |                   | $I_P = I_{PR}(\max); T_A = 85^\circ\text{C}$                       | -    | $1 \pm 2$           | -    | %     |
|  |                   | $I_P = I_{PR}(\max); T_A = 125^\circ\text{C}$                      | -    | $2 \pm 3$           | -    | %     |
|  |                   | $I_P = I_{PR}(\max); T_A = -40^\circ\text{C}$                      | -    | $\pm 3$             | -    | %     |
| <b>TOTAL OUTPUT ERROR COMPONENTS [3] <math>E_{TOT} = E_{SENS} + 100 \times V_{OE}/(Sens \times I_P)</math></b> |                   |  |      |                     |      |       |
| Sensitivity Error  | $E_{SENS}$        | $T_A = 25^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$  | -4   | $\pm 2$             | 4    | %     |
|  |                   | $T_A = 85^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$  | -    | $1 \pm 2$           | -    | %     |
|  |                   | $T_A = 125^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$ | -    | $2 \pm 3$           | -    | %     |
|  |                   | $T_A = -40^\circ\text{C}; \text{ measured at } I_P = I_{PR}(\max)$ | -    | $\pm 3$             | -    | %     |
| Voltage Offset Error [4]   | $V_{OE}$          | $T_A = 25^\circ\text{C}; I_P = 0 \text{ A};$                       | -40  | $\pm 8$             | 40   | mV    |
|  |                   | $T_A = 85^\circ\text{C}; I_P = 0 \text{ A};$                       | -    | $\pm 10$            | -    | mV    |
|  |                   | $T_A = 125^\circ\text{C}; I_P = 0 \text{ A};$                      | -    | $\pm 15$            | -    | mV    |
|  |                   | $T_A = -40^\circ\text{C}; I_P = 0 \text{ A}$                       | -    | $\pm 15$            | -    | mV    |
| <b>LIFETIME DRIFT CHARACTERISTICS</b>  |                   |  |      |                     |      |       |
| Sensitivity Error Lifetime Drift   | $E_{SENS\_DRIFT}$ |  | -    | $\pm 2$             | -    | %     |
| Total Output Error Lifetime Drift  | $E_{TOT\_DRIFT}$  |  | -    | $\pm 2$             | -    | %     |

[1] Typical values with  $\pm$  are 3 sigma values.

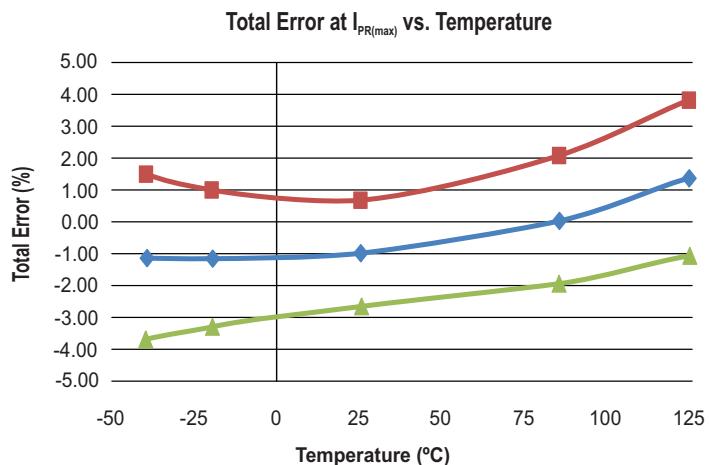
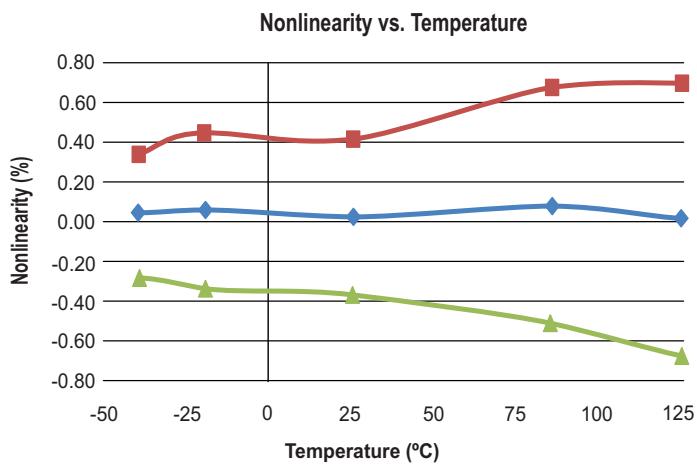
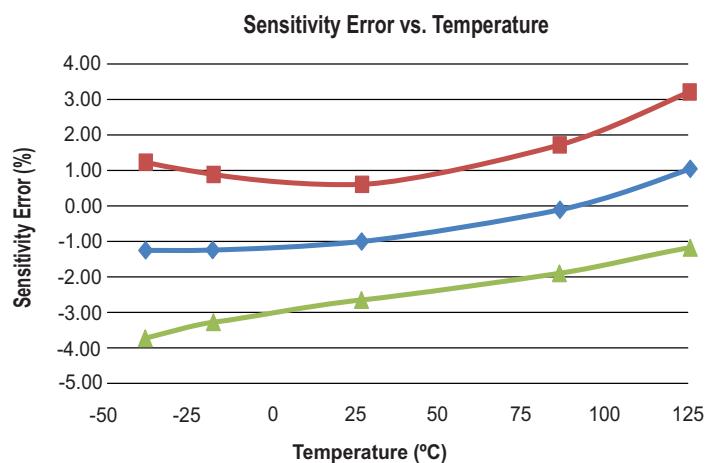
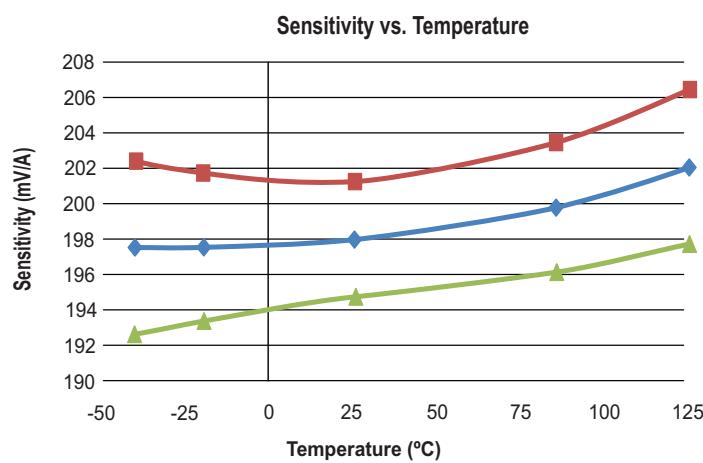
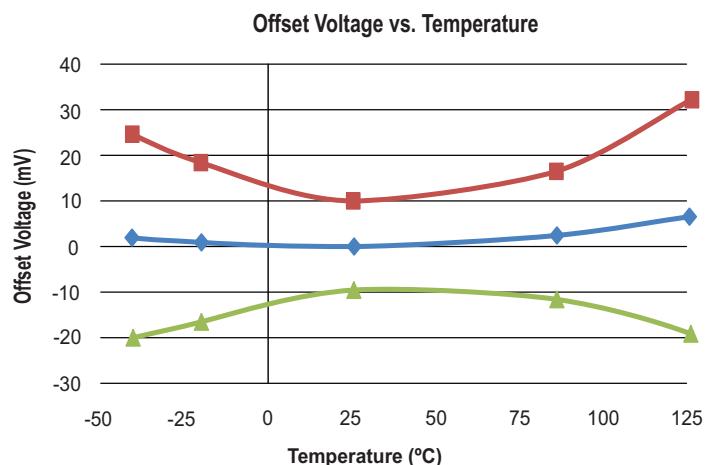
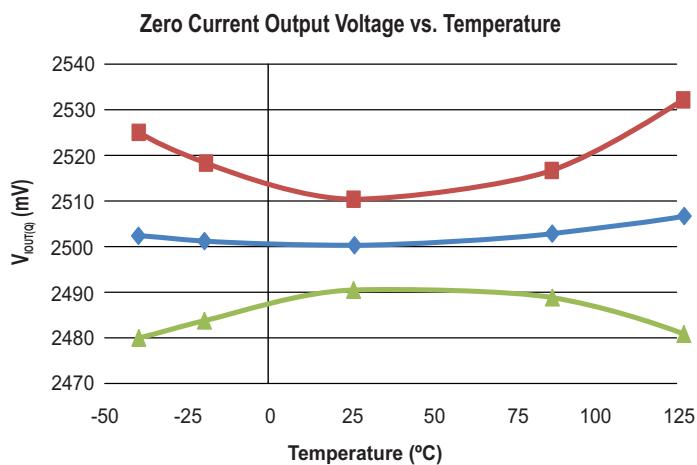
[2] Percentage of  $I_P$ , with  $I_P = I_{PR}(\max)$ .

[3] A single part will not have both the maximum/minimum sensitivity error and maximum/minimum offset voltage, as that would violate the maximum/minimum total output error specification. Also, 3 sigma distribution values are combined by taking the square root of the sum of the squares. See Application Information section.

[4] Voltage Offset Error does not incorporate any error due to external magnetic fields. See section: Impact of External Magnetic Fields.

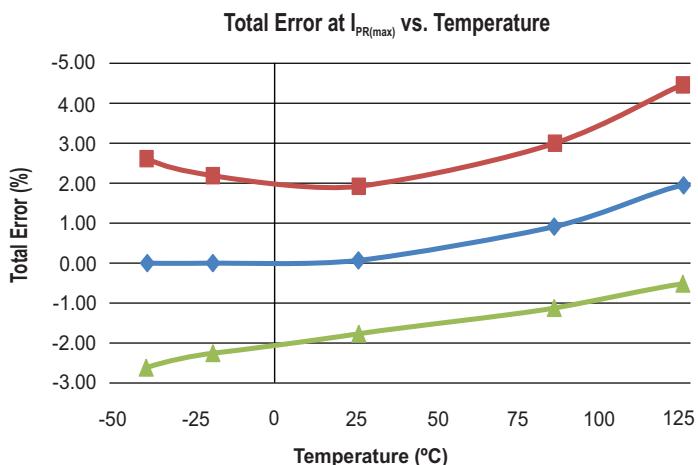
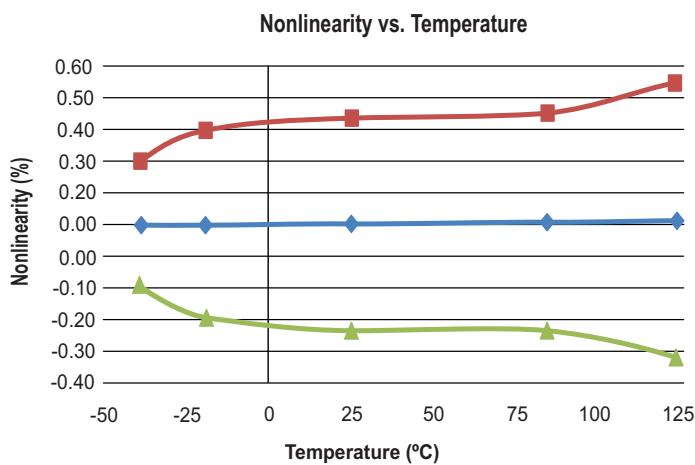
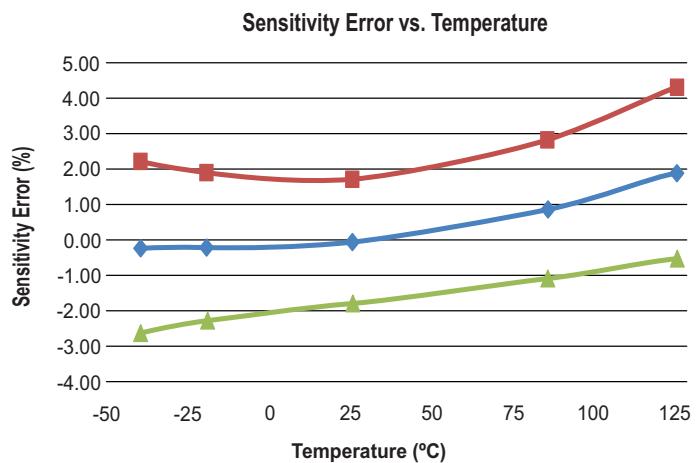
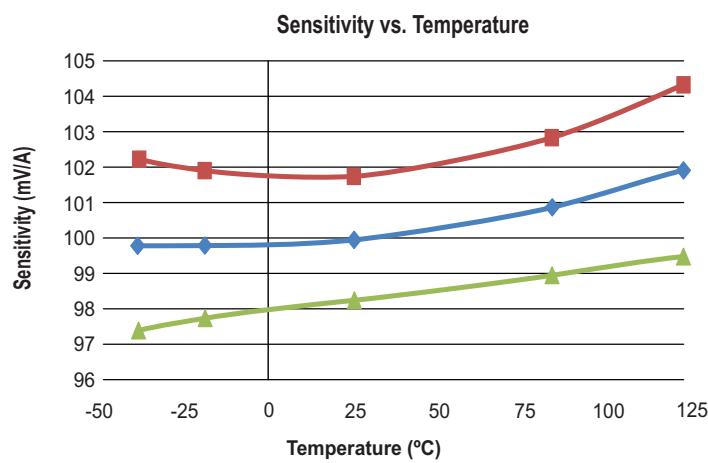
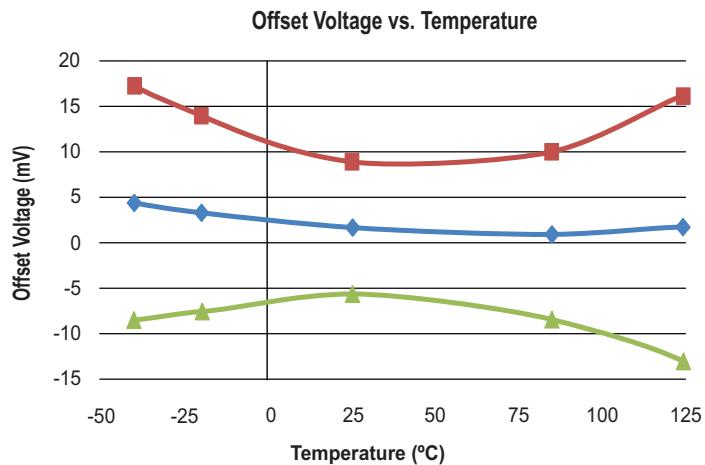
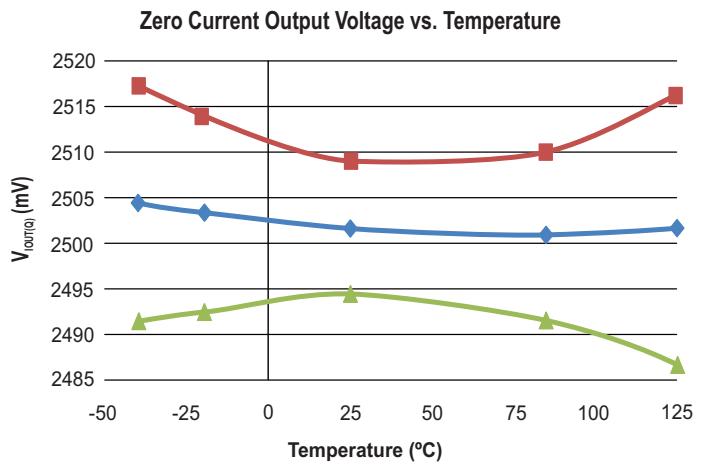
## CHARACTERISTIC PERFORMANCE

## xKMATR-10B Key Parameters



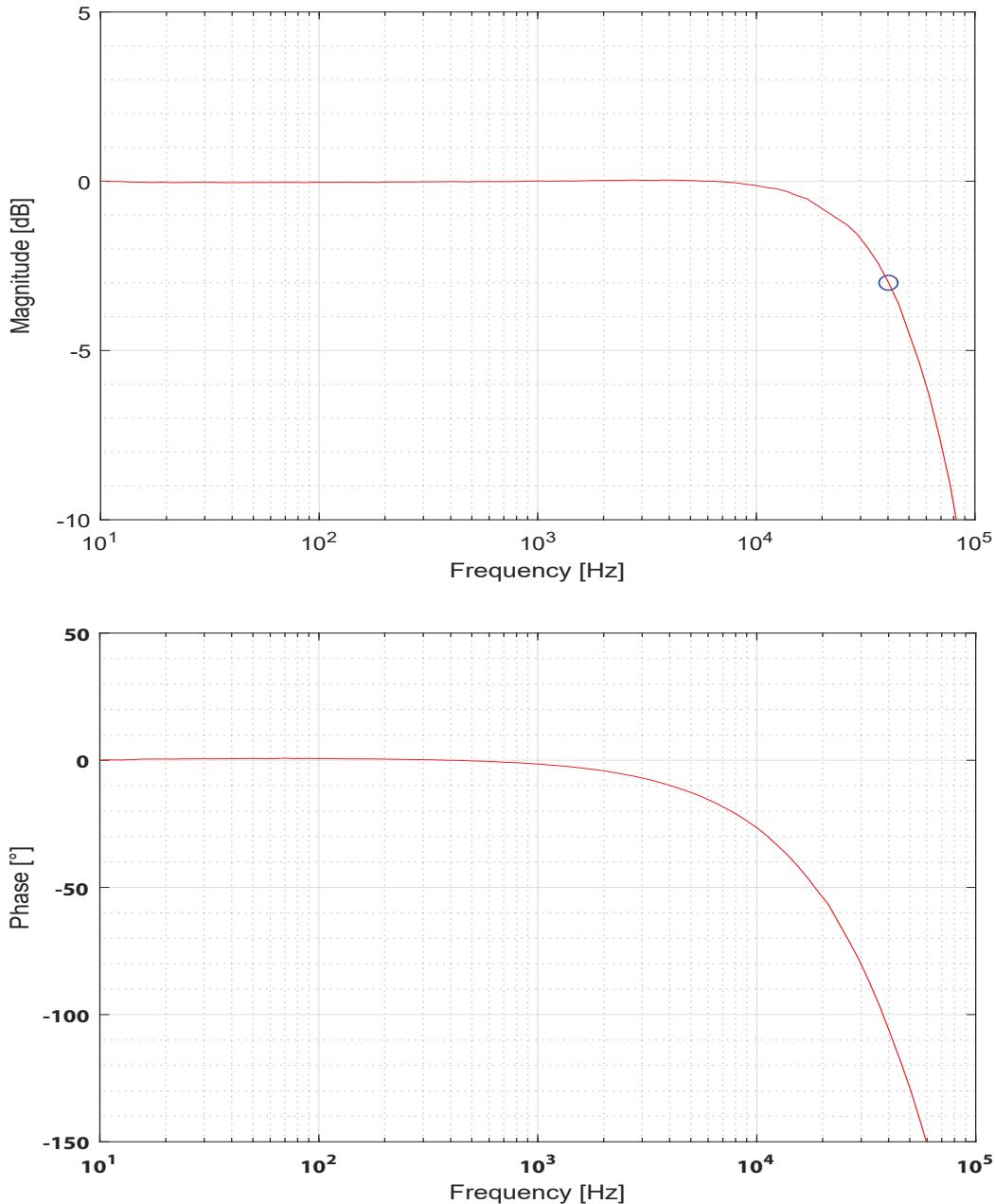
—+3 Sigma    — Average    — -3 Sigma

## xKMATR-20B Key Parameters



—+— +3 Sigma   —○— Average   —△— -3 Sigma

### CHARACTERISTIC PERFORMANCE ACS718 TYPICAL FREQUENCY RESPONSE



For information regarding bandwidth characterization methods used for the ACS718, see the “Characterizing System Bandwidth” application note (<https://www.allegromicro.com/en/insights-and-innovations/technical-documents/hall-effect-sensor-ic-publications/an-effective-method-for-characterizing-system-bandwidth-an296169>) on the Allegro website.

## RESPONSE CHARACTERISTICS DEFINITIONS AND PERFORMANCE DATA

**Response Time ( $t_{\text{RESPONSE}}$ )**

The time interval between a) when the sensed input current reaches 90% of its final value, and b) when the sensor output reaches 90% of its full-scale value.

**Propagation Delay ( $t_{\text{pd}}$ )**

The time interval between a) when the sensed input current reaches 20% of its full-scale value, and b) when the sensor output reaches 20% of its full-scale value.

**Rise Time ( $t_r$ )**

The time interval between a) when the sensor reaches 10% of its full-scale value, and b) when it reaches 90% of its full-scale value.

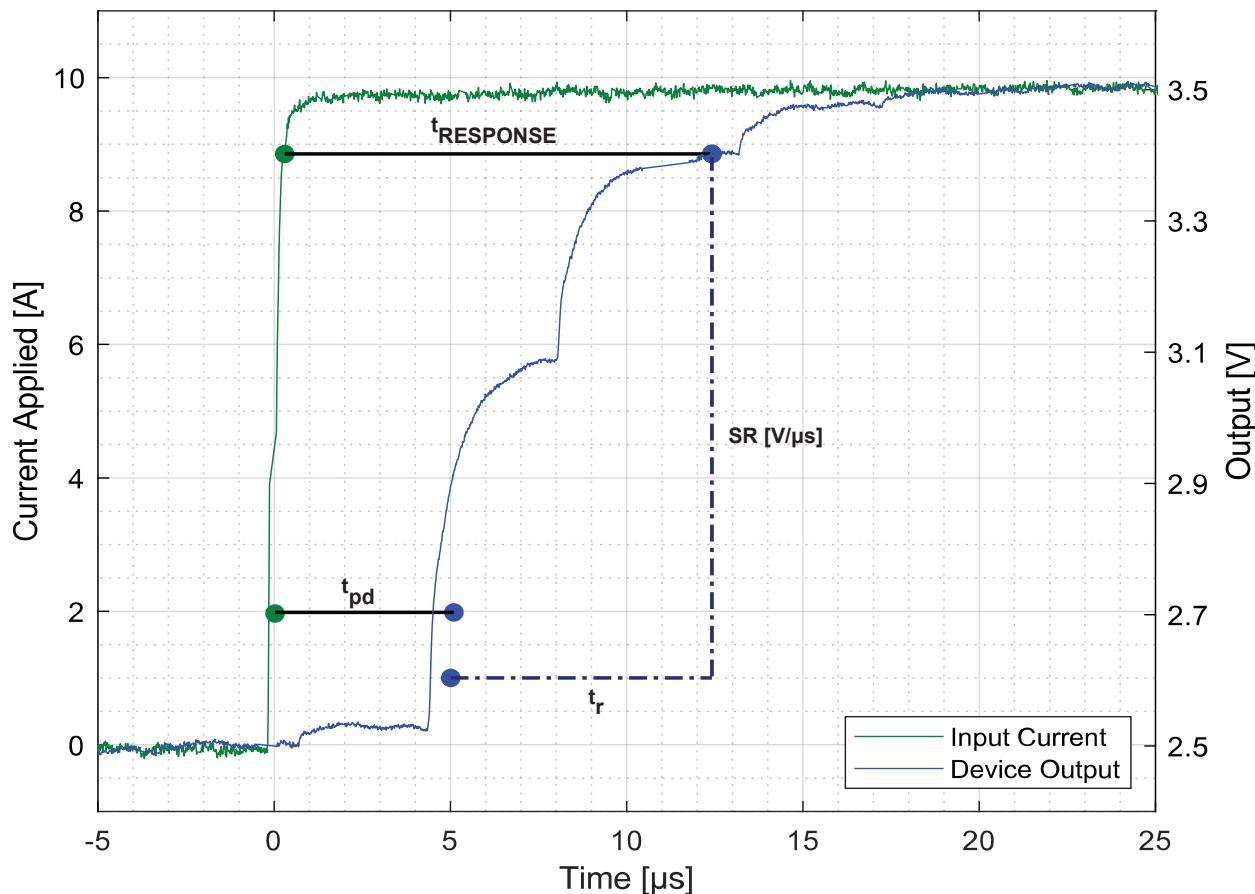
**Output Slew Rate (SR)**

The rate of change [V/ $\mu$ s] in the output voltage from a) when the sensor reaches 10% of its full-scale value, and b) when it reaches 90% of its full-scale value.

**Response Time, Propagation Delay, Rise Time, and Output Slew Rate**

Applied current step with 10%-90% rise time = 0.3  $\mu$ s

Test Conditions:  $T_A = 25^\circ\text{C}$ ,  $C_{\text{BYPASS}} = 0.1 \mu\text{F}$ ,  $C_L = 0 \text{ F}$



## POWER ON FUNCTIONAL DESCRIPTION AND PERFORMANCE DATA

Power-On Time ( $t_{PO}$ )

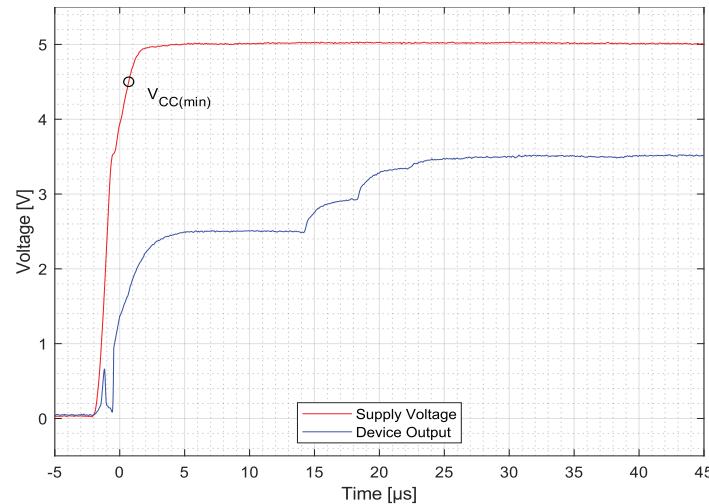
When the supply is ramped to its operating voltage, the device requires a finite amount of time to power its internal components before responding to an input magnetic field. Power-On Time ( $t_{PO}$ ) is defined as the time interval between a) the power supply has reached its minimum specified operating voltage ( $V_{CC(min)}$ ), and b) when the sensor output has settled within  $\pm 10\%$  of its steady-state value under an applied magnetic field.

## Power-On Profile

After applying power, the part remains off in a known state referred to as Power-on Reset, or POR. The device stays in this state until the voltage reaches a point at which the device will remain powered. The power-on profile below illustrates the intended power on/off. A pull-down resistor was used on the output of the tested device.

Power-On Time ( $t_{PO}$ )

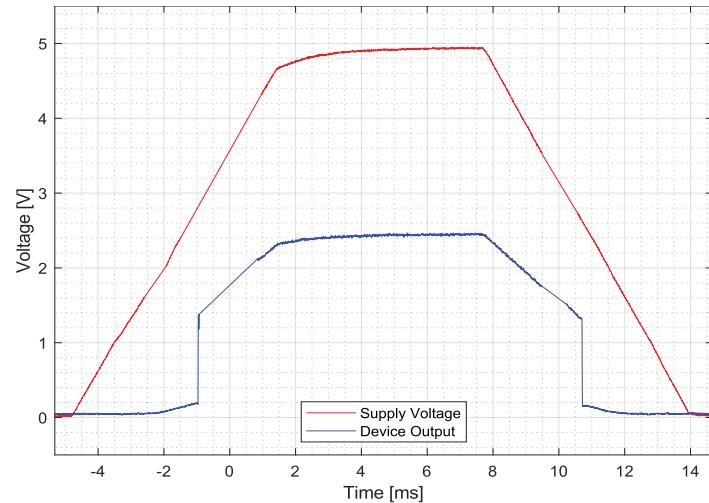
Test Conditions:  $T_A = 25^\circ\text{C}$ ,  $C_{BYPASS} = 0.1 \mu\text{F}$ ,  $R_{PD} = 10 \text{ k}\Omega$



## Power-On Profile

Supply voltage ramp rate = 1V/ms

Test Conditions:  $T_A = 25^\circ\text{C}$ ,  $C_{BYPASS} = 0.1 \mu\text{F}$ ,  $R_{PD} = 10 \text{ k}\Omega$



## DEFINITIONS OF ACCURACY CHARACTERISTICS

**Sensitivity (Sens).** The change in sensor IC output in response to a 1 A change through the primary conductor. The sensitivity is the product of the magnetic circuit sensitivity (G/A) (1 G = 0.1 mT) and the linear IC amplifier gain (mV/G). The linear IC amplifier gain is programmed at the factory to optimize the sensitivity (mV/A) for the full-scale current of the device.

**Nonlinearity ( $E_{LIN}$ ).** The nonlinearity is a measure of how linear the output of the sensor IC is over the full current measurement range. The nonlinearity is calculated as:

$$100 \left\{ 1 - \left[ \frac{\Delta \text{gain} \times \% \text{ sat} (V_{IOUT\_full-scale \text{ amperes}} - V_{IOUT(Q)})}{2 (V_{IOUT\_half-scale \text{ amperes}} - V_{IOUT(Q)})} \right] \right\}$$

where  $V_{IOUT}(I_{PR}(\text{max}))$  is the output of the sensor IC with the maximum measurement current flowing through it and  $V_{IOUT}(I_{PR}(\text{max})/2)$  is the output of the sensor IC with half of the maximum measurement current flowing through it.

**Zero Current Output Voltage ( $V_{IOUT(Q)}$ ).** The output of the sensor when the primary current is zero. For a unipolar supply voltage, it nominally remains at  $0.5 \times V_{CC}$  for a bidirectional device and  $0.1 \times V_{CC}$  for a unidirectional device. For example, in the case of a bidirectional output device,  $V_{CC} = 5 \text{ V}$  translates into  $V_{IOUT(Q)} = 2.5 \text{ V}$ . Variation in  $V_{IOUT(Q)}$  can be attributed to the resolution of the Allegro linear IC quiescent voltage trim and thermal drift.

**Voltage Offset Error ( $V_{OE}$ ).** The deviation of the device output from its ideal quiescent value of  $0.5 \times V_{CC}$  (bidirectional) or  $0.1 \times V_{CC}$  (unidirectional) due to nonmagnetic causes. To convert this voltage to amperes, divide by the device sensitivity, Sens.

**Total Output Error ( $E_{TOT}$ ).** The difference between the current measurement from the sensor IC and the actual current ( $I_P$ ), relative to the actual current. This is equivalent to the difference between the ideal output voltage and the actual output voltage, divided by the ideal sensitivity, relative to the current flowing through the primary conduction path:

$$E_{TOT}(I_P) = \frac{V_{IOUT\_ideal}(I_P) - V_{IOUT}(I_P)}{\text{Sens}_{ideal}(I_P) \times I_P} \times 100 \text{ (%)}$$

The Total Output Error incorporates all sources of error and is a function of  $I_P$ . At relatively high currents,  $E_{TOT}$  will be mostly due to sensitivity error, and at relatively low currents,  $E_{TOT}$  will be mostly due to Voltage Offset Error ( $V_{OE}$ ). In fact, at  $I_P = 0$ ,  $E_{TOT}$  approaches infinity due to the offset. This is illustrated in figures 1 and 2. Figure 1 shows a distribution of output voltages versus  $I_P$  at 25°C and across temperature. Figure 2 shows the corresponding  $E_{TOT}$  versus  $I_P$ .

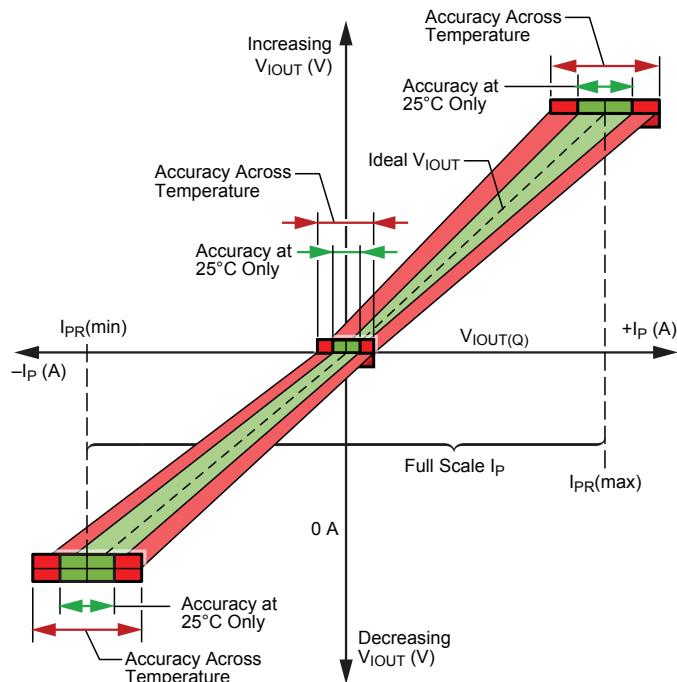


Figure 1: Output Voltage versus Sensed Current

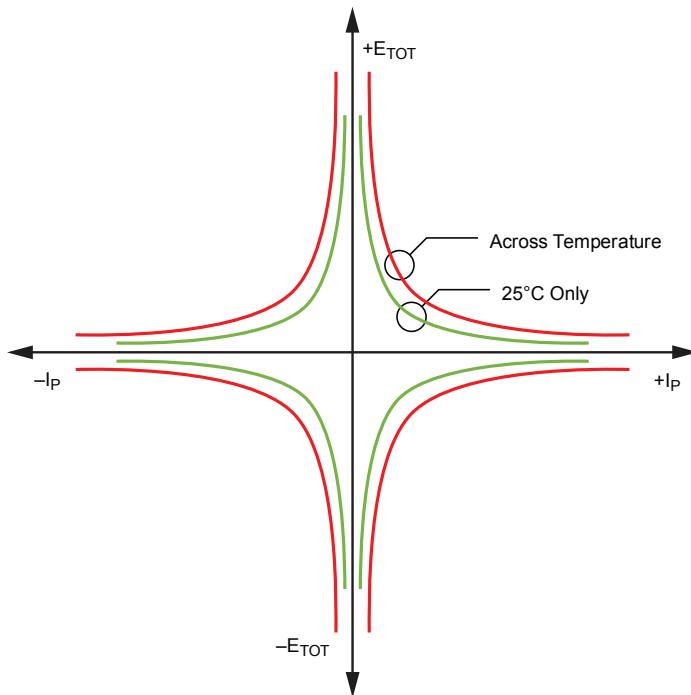


Figure 2: Total Output Error versus Sensed Current

## APPLICATION INFORMATION

**Impact of External Magnetic Fields**

The ACS718 works by sensing the magnetic field created by the current flowing through the package. However, the sensor cannot differentiate between fields created by the current flow and external magnetic fields. This means that external magnetic fields can cause errors in the output of the sensor. Magnetic fields which are perpendicular to the surface of the package affect the output of the sensor, as it only senses fields in that one plane. The error in Amperes can be quantified as:

$$\text{Error}(B) = \frac{B}{C_F}$$

where  $B$  is the strength of the external field perpendicular to the surface of the package in Gauss, and  $C_F$  is the coupling factor in G/A. Then, multiplying by the sensitivity of the part (Sens) gives the error in mV.

For example, an external field of 1 Gauss will result in around 0.22 A of error. If the ACS718KMATR-10B, which has a nominal sensitivity of 200 mV/A, is being used, that equates to 44 mV of error on the output of the sensor.

**Table 1: External Magnetic Field (Gauss) Impact**

| External Field (Gauss) | Error (A) | Error (mV) |     |
|------------------------|-----------|------------|-----|
|                        |           | 10B        | 20B |
| 0.5                    | 0.11      | 22         | 11  |
| 1                      | 0.22      | 44         | 22  |
| 2                      | 0.44      | 88         | 44  |

**Estimating Total Error vs. Sensed Current**

The Performance Characteristics tables give distribution ( $\pm 3$  sigma) values for Total Error at  $I_{PR(\max)}$ ; however, one often wants to know what error to expect at a particular current. This can be estimated by using the distribution data for the components of Total Error, Sensitivity Error, and Voltage Offset Error.

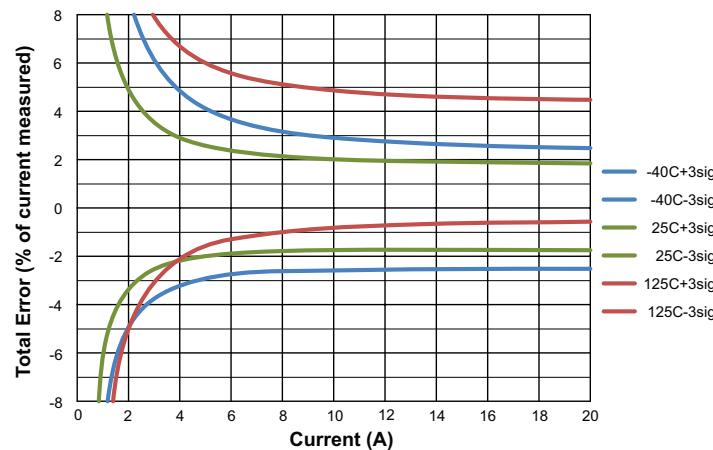
The  $\pm 3$  sigma value for Total Error ( $E_{TOT}$ ) as a function of the sensed current ( $I_p$ ) is estimated as:

$$E_{TOT}(I_p) = \sqrt{E_{SENS}^2 + \left( \frac{100 \times V_{OE}}{Sens \times I_p} \right)^2}$$

Here,  $E_{SENS}$  and  $V_{OE}$  are the  $\pm 3$  sigma values for those error terms. If there is an average sensitivity error or average offset voltage, then the average Total Error is estimated as:

$$E_{TOT_AVG}(I_p) = E_{SENS_AVG} + \frac{100 \times V_{OE_AVG}}{Sens \times I_p}$$

The resulting total error will be a sum of  $E_{TOT}$  and  $E_{TOT\_AVG}$ . Using these equations and the 3 sigma distributions for Sensitivity Error and Voltage Offset Error, the Total Error vs. sensed current ( $I_p$ ) is below for the ACS718KMATR-20B. As expected, as one goes towards zero current, the error in percent goes towards infinity due to division by zero (refer to Figure 3).

**Figure 3: Predicted Total Error as a Function of Sensed Current for the ACS718KMATR-20B**

## Thermal Rise vs. Primary Current

Self-heating due to the flow of current should be considered during the design of any current sensing system. The sensor, printed circuit board (PCB), and contacts to the PCB will generate heat as current moves through the system.

The thermal response is highly dependent on PCB layout, copper thickness, cooling techniques, and the profile of the injected current. The current profile includes peak current, current “on-time”, and duty cycle. While the data presented in this section was collected with Direct-Current (DC), these numbers may be used to approximate thermal response for both AC signals and current pulses.

The plot in Figure 4 shows the measured rise in steady-state die temperature of the ACS718 versus continuous current at an ambient temperature,  $T_A$ , of 25 °C. The thermal offset curves may be directly applied to other values of  $T_A$ . Conversely, Figure 5 shows the maximum continuous current at a given  $T_A$ . Surges beyond the maximum current listed in Figure 5 are allowed given the maximum junction temperature,  $T_{J(MAX)}$  (165°C), is not exceeded.

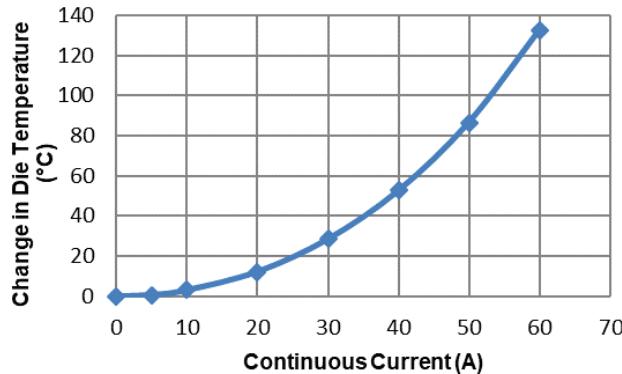


Figure 4: Self-Heating in the MA Package  
Due to Current Flow

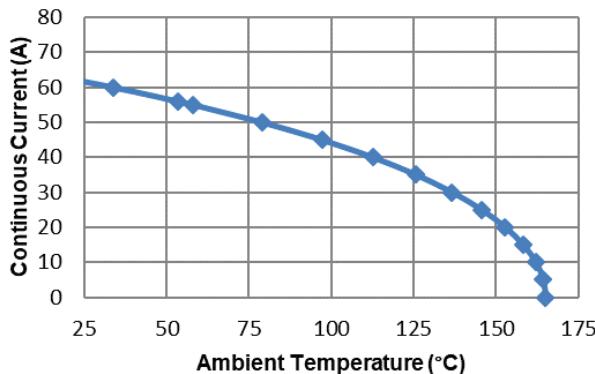


Figure 5: Maximum continuous current  
at a given  $T_A$

The thermal capacity of the ACS718 should be verified by the end user in the application’s specific conditions. The maximum junction temperature,  $T_{J(MAX)}$  (165°C), should not be exceeded. Further information on this application testing is available in the [DC and Transient Current Capability](#) application note on the Allegro website.

## ASEK718 Evaluation Board Layout

Thermal data shown in Figure 4 and Figure 5 was collected using the ASEK718 Evaluation Board (TED-85-0667-002). This board includes 1500 mm<sup>2</sup> of 4 oz. copper (0.1388 mm) connected to pins 1 through 4, and to pins 5 through 8, with thermal vias connecting the layers. Top and Bottom layers of the PCB are shown below in Figure 6.

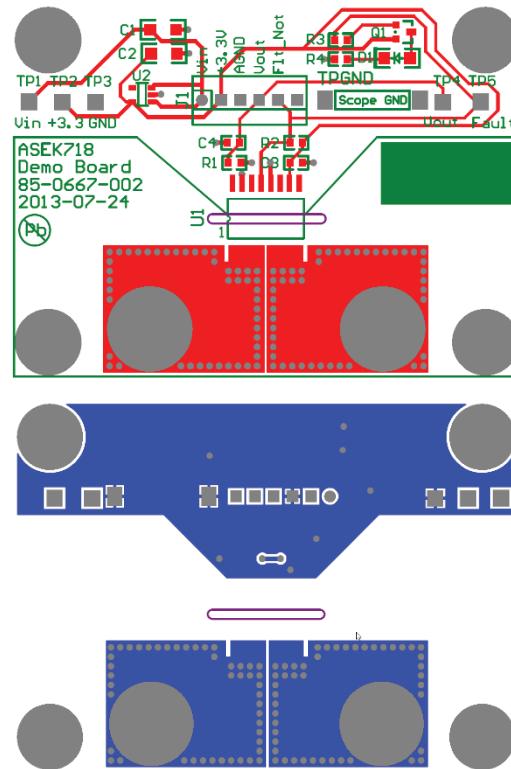
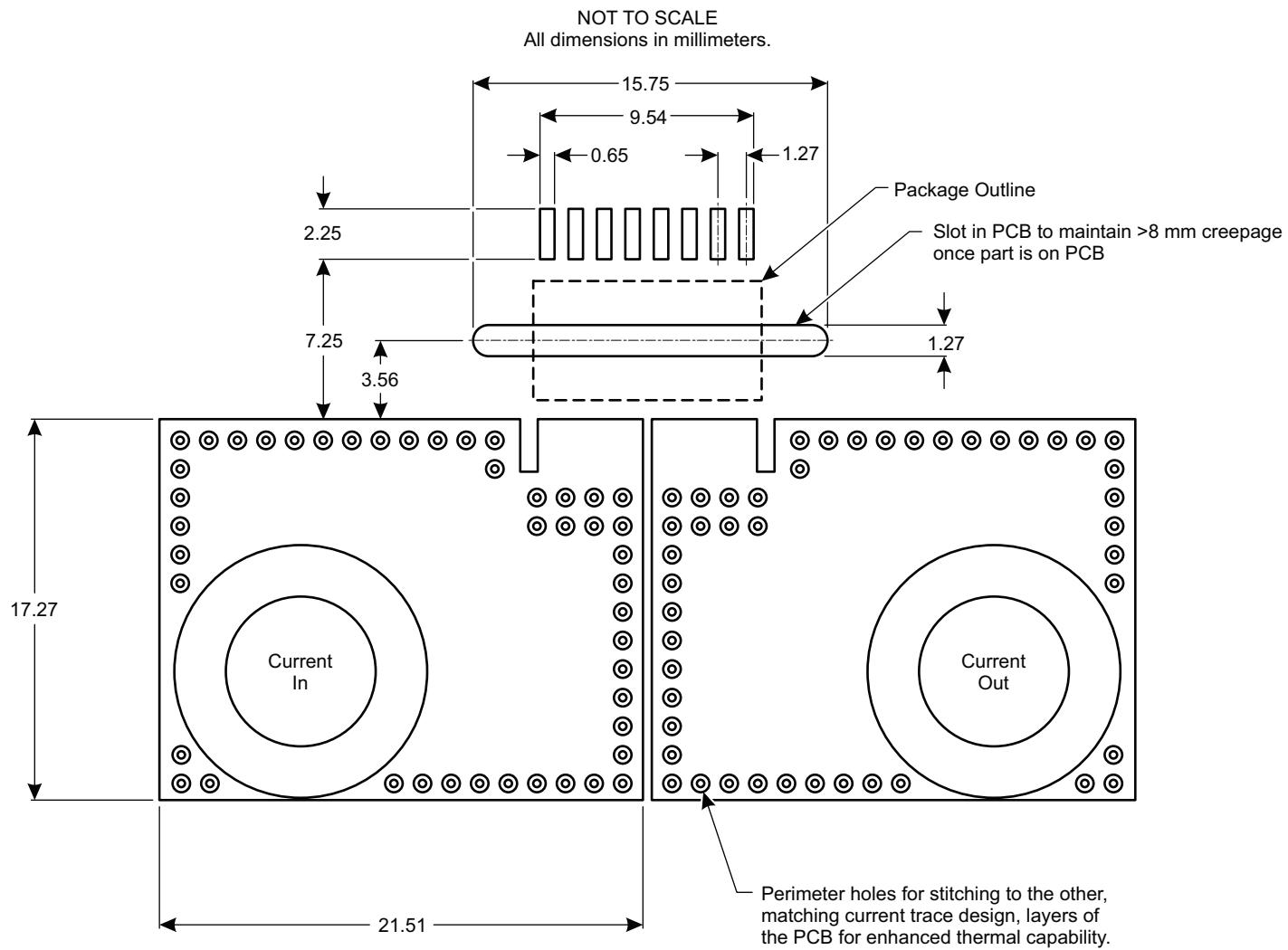


Figure 6: Top and Bottom Layers for  
ASEK718 Evaluation Board

## HIGH ISOLATION PCB LAYOUT



## PACKAGE OUTLINE DRAWING

## For Reference Only – Not for Tooling Use

(Reference Allegro DWG-0000388, Rev. 1 and JEDEC MS-013AA)

NOT TO SCALE

Dimensions in millimeters

Dimensions exclusive of mold flash, gate burrs, and dambar protrusions

Exact case and lead configuration at supplier discretion within limits shown

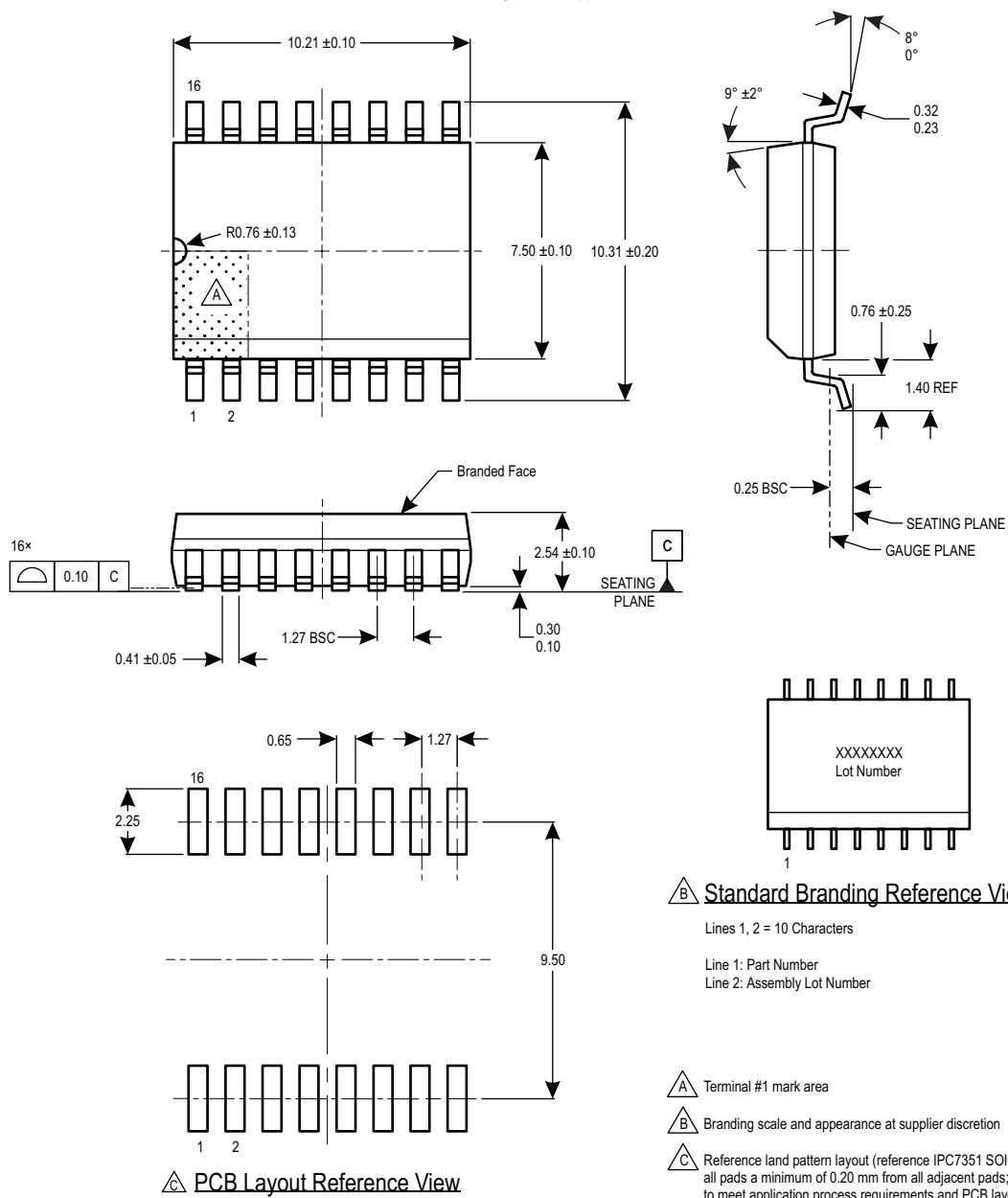


Figure 7: Package MA, 16-pin SOICW

## Revision History

| Number | Date              | Description   |
|--------|-------------------|---|
| -      | December 15, 2014 | Initial Release   |
| 1      | June 15, 2015     | Corrected pinout diagram  |
| 2      | April 13, 2016    | Corrected Package Outline Drawing branding information (page 13).   |
| 3      | December 14, 2018 | Updated certificate numbers and minor editorial updates   |
| 4      | May 21, 2019      | Updated TUV certificate mark  |
| 5      | April 6, 2020     | Added Maximum Current to Absolute Maximum Ratings table (page 2); added ESD Ratings Table (page 2); updated Isolation Characteristics Table (page 2); updated Rise Time, Response Time, Propagation Delay, Output Slew Rate, and Power-On Time test conditions (page 4); added Primary Conductor Inductance and Output Slew Rate values (page 4); corrected Offset Voltage to Voltage Offset Error (pages 5-13); added Typical Frequency Response (page 9); added Response Characteristics Definitions and Performance Data (page 10); added Power On Functional Description and Performance Data (page 11); added thermal data section (page 12) |
| 6      | May 2, 2022       | Updated package drawing (page 16) and minor editorial updates   |
| 7      | November 1, 2023  | Updated product status to NND   |
| 8      | December 9, 2024  | Fixed broken links (pages 9 and 14)   |
| 9      | March 13, 2025    | Added product alternatives (cover sheet), and removed reference to availability of ASEK Gerber files on web site (page 14)  |

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